

# INTELLIGENT POWER HIGH SIDE SWITCH

### **Features**

- Over temperature shutdown (with auto-restart)
- Short circuit protection (current limit)
- Reverse battery protection (turns On the MOSFET)
- Full diagnostic capability (short circuit to battery)
- Active clamp
- Open load detection in On and Off state
- Ground loss protection
- · Logic ground isolated from power ground
- ESD protection
- Lead Free and RoHS compliant

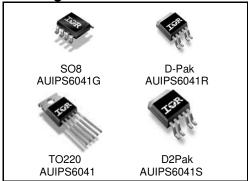
### Description

The AUIPS6041(G)(R)(S) is a five terminal Intelligent Power Switch (IPS) for use in a high side configuration. It features short circuit, over-temperature, ESD protection, inductive load capability and diagnostic feedback. The output current is limited to the llim value. The current limitation is activated until the thermal protection acts. The over-temperature protection turns off the device if the junction temperature exceeds the Tshutdown value. It will automatically restart after the junction has cooled 7°C below the Tshutdown value. The reverse battery protection turns On the MOSFET. A diagnostic pin provides different voltage levels for each fault condition. The double level shifter circuitry will allow large offsets between the logic and load ground.

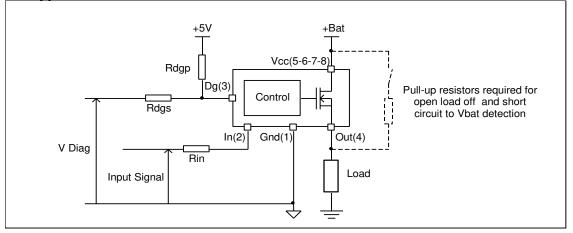
# **Product Summary**

 $\begin{array}{ll} \text{Rds(on)} & 130\text{m}\Omega \text{ max.} \\ \text{Vclamp} & 39\text{V} \\ \text{I Limit} & 7\text{A} \\ \text{Open load} & 3\text{V} \, / \, 0.22\text{A} \end{array}$ 

# **Packages**



# **Typical Connection**





# Qualification Information<sup>†</sup>

			Automotive (per AEC-Q100 <sup>††</sup> )		
Qualificat	tion Level	Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
		D2PAK-5L	MSL1, 260°C (per IPC/JEDEC J-STD-020)		
Moisture Sensitivity Level		TO-220	Not applicable (non-surface mount package style)		
Moisture	Sensitivity Level	DPAK-5L MSL1, 260°C (per IPC/JEDEC J-STD			
		SOIC-8L	MSL2, 260°C (per IPC/JEDEC J-STD-020)		
	Machine Model		Class M2 (+/-150V) **** (per AEC-Q100-003)		
ESD	Human Body Model	· ·	Class H1C (+/-1500V) *** (per AEC-Q100-002)		
ESD	Charged Device Model (SOIC, DPAK,D2PAK)	Class C4 (+ (per AEC-0			
	Charged Device Model (TO220)	Class C3B (+/-750V) fff (per AEC-Q100-011)			
IC Latch-	Up Test	Class II, Level A (per AEC-Q100-004)			
RoHS Co	mpliant		Yes		

<sup>†</sup> Qualification standards can be found at International Rectifier's web site <a href="http://www.irf.com/">http://www.irf.com/</a>

<sup>††</sup> Exceptions to AEC-Q100 requirements are noted in the qualification report.

<sup>†††</sup> Passing voltage level



# **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters

are referenced to Ground lead. Tj= -40°C..150°C, Vcc=6..35V (unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
Vout	Maximum output voltage	Vcc-35	Vcc+0.3	
Voffset	Maximum logic ground to load ground offset	Vcc-35	Vcc+0.3	
Vin	Maximum input voltage	-0.3	5.5	V
Vcc max.	Maximum Vcc voltage	_	36	
Vcc cont.	Maximum continuous Vcc voltage	_	28	
lin max.	Maximum IN current	-3	10	mA
ldg max.	Maximum diagnostic output current	-3	10	ША
Vdg	Maximum diagnostic output voltage	-0.3	5.5	٧
Pulse 2a max	Maximum voltage ISO pulse 2a x 500cy (ISO7637)	_	55	٧
	Maximum power dissipation (internally limited by thermal protection)	_	1.25	
Pd	Rth=100°C/W AUIPS6041G		_	W
	Rth=50°C/W AUIPS6041R 1"sqrt. footprint	_	2.5	
Tj max.	Max. storage & operating temperature junction temperature	-40	150	Ô

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
Rth1	Thermal resistance junction to ambient AUIPS6041G	100	_	
Rth1	Thermal resistance junction to ambient AUIPS6041R D-Pak std. footprint	70		
Rth2	Thermal resistance junction to ambient AUIPS6041R D-Pak 1" sqrt. footprint	50	_	
Rth3	Thermal resistance junction to case AUIPS6041(R)(S) D-Pak/D2pak/TO220	6	_	°C/W
Rth1	Thermal resistance junction to ambient AUIPS6041(S) D2Pak/TO220 std. footprint	60	_	
Rth2	Thermal resistance junction to ambient AUIPS6041S D2Pak 1" sqrt. footprint	40	_	

Recommended Operating Conditions

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
VIH	High level input voltage	4	5.5	
VIL	Low level input voltage	0	0.9	
lout	Continuous drain current, Tambient=85°C, Tj=125°C, Vin=5V			
iout	Rth=100°C/W AUIPS6041G	_	1.6	Α
	Rth=50°C/W AUIPS6041R 1" sqrt. footprint	_	2.3	_ A
Rin	Recommended resistor in series with IN pin	4	10	
Rdgs	Recommended resistor in series with DG pin for reverse battery protection	4	20	1.0
Rdgp	Recommended pull-up resistor for DG	4	20	kΩ
Rol	Recommended pull-up resistor for open load detection	5	100	
F max.	Max. switching frequency	_	3.5	kHz



# **Static Electrical Characteristics**

Tj=-40°C..150°C, Vcc=6..28V (unless otherwise specified), typical values are given for Vcc=14V and Tj=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
	ON state resistance Tj=25°C	_	110	130		Vin=5V, lout=2.5A
	ON state resistance Tj=150°C	_	190	230		Vin=5V, lout=2.5A
Rds(on)	ON state resistance Tj=25°C, Vcc=6V	_	125	155	$m\Omega$	Vin=5V, lout=1.5A
	ON state resistance during reverse battery Tj=25°C		140	180		Vcc-Gnd=-14V
Vcc op.	Operating voltage range	6	_	28		
V clamp 1	Vcc to Out clamp voltage 1	37	39	43	V	lout=20mA
V clamp 2	Vcc to Out clamp voltage 2	_	40	_		lout=2.5A (see Fig. 1)
Icc Off	Supply current when Off and with Vout connected to ground Rconnection $<4\Omega$		4	9	μΑ	Vin=0V, Vout=0V, Tj=25°C, Vcc=14V
Icc On	Supply current when On	_	2.2	5	mA	Vin=5V, Vcc=14V
Vih	Input high threshold voltage	_	2.5	3		
Vil	Input low threshold voltage	1.5	2	_	V	
In hyst.	Input hysteresis	0.2	0.5	1		
lin On	Input current when device is On	_	40	100		Vin=5V
ldg	Dg leakage current	_	0.1	10	μΑ	Vdg=5V
Vdg	Low level DG voltage	_	0.25	0.4	V	ldg=1.6mA

# **Switching Electrical Characteristics**

Vcc=14V, Resistive load=6Ω, Vin=5V, Tj=-40°C..150°C, typical values are given for Tj=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Tdon	Turn-on delay time		5	15		
Tr1	Rise time to Vout=Vcc-5V		3	10	μs	
Tr2	Rise time to Vout=0.9 x Vcc		4	30		
dV/dt (On)	Turn On dV/dt		2.5	_	V/µs	
EOn	Turn On energy	_	100	_	μJ	see Fig. 3
Tdoff	Turn-off delay time	_	10	20		
Tf	Fall time to Vout=0.1 x Vcc	_	3	10	μs	
dV/dt (Off)	Turn Off dV/dt	_	6.5	_	V/µs	]
EOff	Turn Off energy	_	50	_	μJ	]



## **Protection Characteristics**

Tj=-40°C..150°C, Vcc=6..28V (unless otherwise specified), typical values are given for Vcc=14V and Tj=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
llim	Internal current limit	4	7	10	Α	Vout=0V, Tj=25°C
Tsd+	Over temperature high threshold	150(1)	165	_	°C	See fig. 2
Tsd-	Over temperature low threshold		158	_	C	See lig. 2
Vsc	Short-circuit detection voltage(2)	2	3	4		
UV+		_	5	6.2	.,	
UV -		_	4.5	5.8	V	
VOL Off	Open load detection threshold	2	3	4		
I OL On	Open load detection threshold	0.05	0.17	0.27	Α	Tj=-4025°C
TOLON		0.05	0.15	0.22		Tj=25150°C

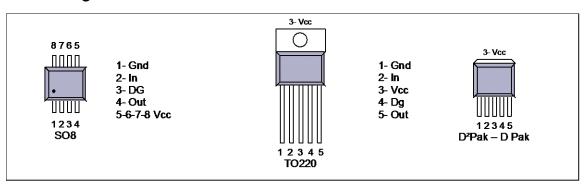
<sup>(1)</sup> Guaranteed by design

## **True Table**

Operating Conditions	IN	OUT	DG
Normal	Н	Н	Н
Normal	L	L	Н
Open Load	Н	Н	L
Open Load (3)	L	Н	L
Short circuit to Gnd	Н	L	L
Short circuit to Gnd	L	L	Н
Short circuit to Vcc	Н	Н	L (4)
Short circuit to Vcc (5)	L	Н	L
Over-temperature	Н	L	L
Over-temperature	L	L	Н

<sup>(3)</sup> With a pull-up resistor connected between the output and Vcc.

# **Lead Assignments**

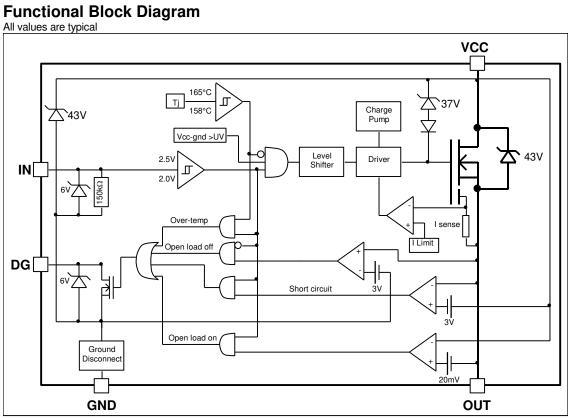


<sup>(2)</sup> Reference to Vcc

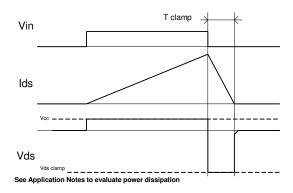
<sup>(4)</sup> Vds lower than 10mV.

<sup>(5)</sup> Without a pull-up resistor connected between the output and Vcc.







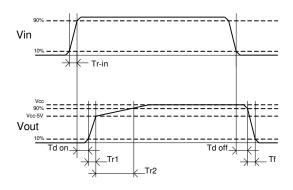


Vin lout limiting Thermal cycling

Ti Tsd+ Tsd
DG

Figure 1 - Active clamp waveforms

Figure 2 - Protection timing diagram



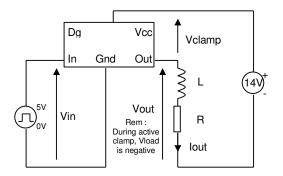


Figure 3 - Switching times definitions

Figure 4 - Active clamp test circuit

10

1

0.1

lout, Output current (A)

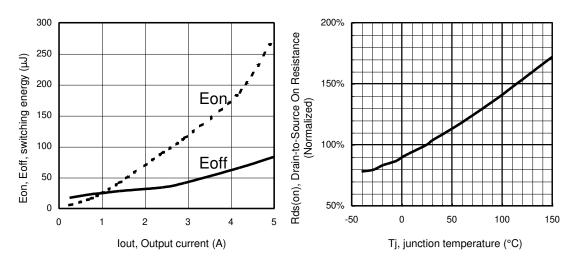


Figure 5 - Switching energy (µJ) Vs Output current (A)

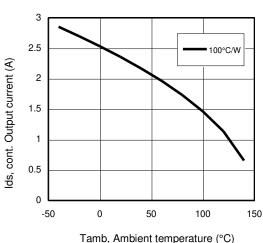
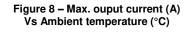


Figure 6 - Normalized Rds(on) (%) Vs Tj (°C)

Figure 7 - Max. Output current (A) Vs Load inductance (mH)



0.1 10 100 1 1000 Load inductance (mH) Tamb, Ambient temperature (°C)

# International TOR Rectifier

# **AUIPS6041(G)(R)(S)**

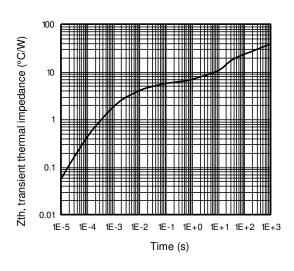
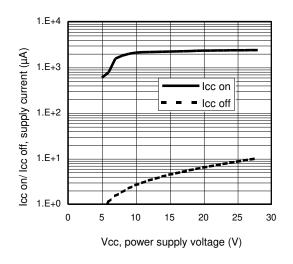


Figure 9 – Transient thermal impedance (°C/W)
Vs time (s)

Figure 10 –I limit (A) Vs junction temperature (°C)



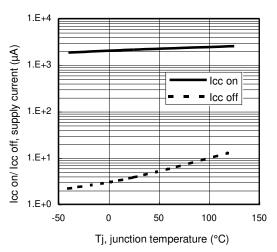


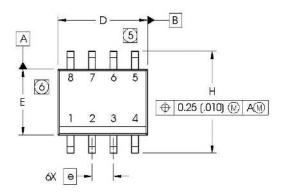
Figure 11 - Icc on/ Icc off (µA) Vs Vcc (V)\*

Figure 12 - Icc on/ Icc off (μA) Vs Tj (°C)\*

<sup>\*</sup>Vout connected to ground with R<4Ω

## Case Outline - SO8

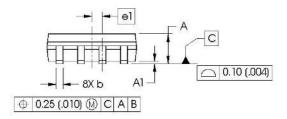
Dimensions are shown in millimeters (inches)

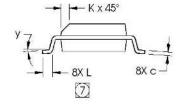


DIM	MIN	MAX	MIN	MAX	
Α	.0532	.0688	1.35	1.75	
A1	.0040	.0098	0.10	0.25	
b	.013	,020	0.33	0.51	
С	.0075	.0098	0.19	0.25	
D	.189	.1968	4.80	5.00	
Ε	.1497	.1574	3.80	4.00	
е	.050 B.	ASIC	1.27 E	BASIC	
e1	.025 B	ASIC	0.635 BASI		
Н	.2284	.2440	5.80	6.20	
К	.0099	.0196	0.25	0.50	
L	.016	.050	0.40	1.27	
γ	0°	8°	0°	8°	

MILLIMETERS

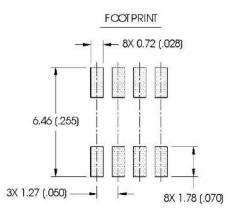
INCHES





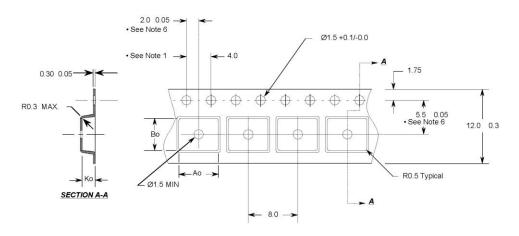
### NOTES:

- 1. DIMENSIONING & TOLERANGING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- (6) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- (7) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERINGTO A SUBSTRATE.





# Tape & Reel - SO8



#### Notes:

- 1. 10 sprocket hole pitch cumulative tolerance 0.2
- 2. Camber not to exceed 1mm in 100mm
- Material: Black Conductive Advantek Polystyrene
   Ao and Bo measured on a plane 0.3mm above the
- 4. Ao and Bo measured on a plane 0.3mm above the bottom of the pocket
- Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

Ao = 6.4 mm

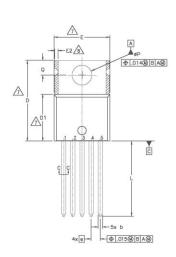
Bo = 5.2 mm

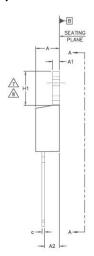
Ko = 2.1 mm

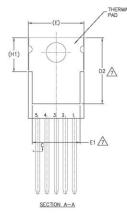
- All Dimensions in Millimeters -



# Case Outline - TO220 (5 leads)







S	DIMENSIONS					
SYMBOL	MILLIME	TERS	INC	HES	OFF	
L	MIN.	MAX.	MIN.	MAX.	S	
A	3.56	4.83	.140	.190	1	
A1	0.51	1.40	.020	.055		
A2	2.03	2.92	.080	.115		
ь	0.64	0.89	.025	.035		
b1	0.64	0.84	.025	.033	5	
c	0.36	0.61	.014	.024		
c1	0.36	0.56	.014	.022	5	
D	14.22	16.51	.560	.650	4	
D1	8.38	9.02	.330	.355		
D2	11.68	12.88	.460	.507	7	
E	9.65	10.67	.380	.420	4,7	
E1	6.86	8.89	.270	.350	7	
E2	-	0.76	-	.030	8	
e	1.70	BSC	.067 BSC		7	
H1	5.84	6.86	.230	.270	7,8	
L	12.70	14.73	.500	.580		
φP	3.53	3.73	.139	.147		
Q	2.54	3.05	.100	.120		

PLATING-	BASE METAL	
(c)	c1 5	

- NOTES:

  DIMENSIONING AND TOLERANCING AS PER ASME Y14.5 M 1994.

  DIMENSIONS ARE SHOWN IN INCHES (MILLIMETERS).

  LEAD DIMENSION AND FINISH UNCONTROLLED IN 11.

  DIMENSION AND FINISH UNCONTROLLED IN 11.

  DIMENSION D. 11 & E DO NOT INCLIDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED, 0.05" (0.12") PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERWOST EXTREMES OF THE PLASTIC BOOY.

  DIMENSION IS & c. 1 APPLY TO BASE METAL ONLY.

  CONTROLING DIMENSION IN KOMES.

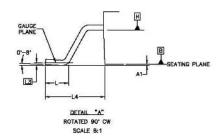
  THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,HI.02 & E1.

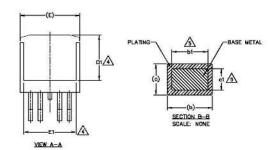
  PLINING FOR 22 H. IN DEFINIS A ZONE MEMERS STAMPHING.

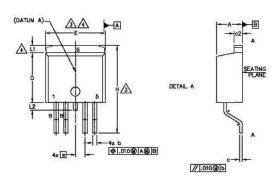
- DIBENSION 22 X H1 DEFINE A ZONE MHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. OUTLINE CONFORMS TO JEDEC TO –220, EXCEPT A2 (max.) AND D2 (min.) WHERE DIMENSIONS ARE DERIVED FROM THE ACTUAL PACKAGE OUTLINE.

10.- LEADS AND DRAIN ARE PLATED WITH 100% Sn

# Case Outline 5 Leads - D2PAK







#### NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- A DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.006"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.

ATHERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.

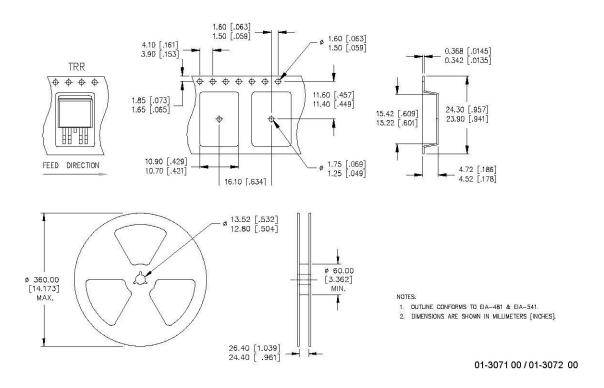
SDIMENSION 61 AND 61 APPLY TO BASE METAL ONLY.

- 6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 7. CONTROLLING DIMENSION: INCH.
- 8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263BA.
- 9 LEADS AND DRAIN ARE PLATED : 100% Sn

5 Y	DIMENSIONS					
B	MILLIN	ETERS	INC	HES	O	
B O L	MIN.	MAX.	MIN.	MAX.	E	
A	4.06	4.83	.160	.190	-	
A1		0.254	-	.010		
ь	0.51	0.99	.020	.039	4	
b1	D.51	0.89	.020	.035	. 600	
c	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	4	
02	1.14	1.65	.045	.065	- 01	
D	8.38	9.65	.330	.380	3	
D1	6.86	2	.270	_		
E	9.65	10.67	.380	.420	3	
E1	6.22	-	.245	3. <del>5</del> 2		
•	1.70	BSC	.067	BSC		
н	14.61	15.88	.575	.625		
L	1.78	2.79	.070	.110		
L1	-	1.68	2	.066		
L2	_	1.78	-	.070		
L3	0.25	BSC	.010	BSC		
L4	4.78	5.28	.188	.208		

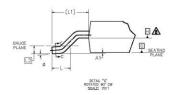


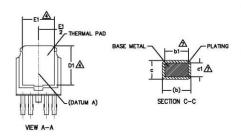
# Tape & Reel 5 Leads - D2PAK

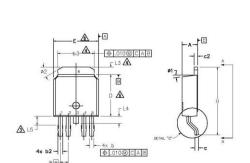




## Case Outline 5 Leads - DPAK





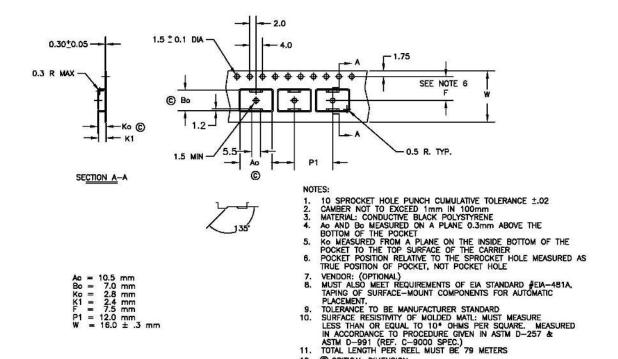


S	DIMENSIONS				
МВО	MILLIMETERS		INC	Ö	
L	MIN.	MAX.	MIN.	MAX.	Ė
Α	2.18	2.39	.086	.094	
A1	_	0.13	-	.005	
ь	0.56	0.79	.022	.031	
<b>b1</b>	.056	0.74	.022	.029	2
b2	0.65	0.89	.026	.035	
b3	4.95	5.46	.195	.215	2
c	0.46	0.61	.018	.024	
c1	0.41	0.56	.016	.022	2
c2	0.46	0.89	.018	.035	
D	5.97	6.22	.235	.245	3
D1	5.21	-	.205	-	
E	6.35	6.73	.250	.265	3
E1	4.32	_	.170	_	
e	1.14	1.14 BSC		BSC	
Н	9.40	10.41	.370	.410	
L	1.40	1.78	.055	.070	
L1	2.74 BSC		.108	REF.	
L2	0.51 BSC		.020	BSC	
L3	0.89	1.27	.035	.050	
L4	_	1.02	_	.040	
L5	1.14	1.52	.045	.060	
ø	0.	10°	0,	10°	
ø1	0.	15*	0.	15°	
ø2	28*	32*	28*	32*	

#### NOTES

- 1.- DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- A- LEAD DIMENSION UNCONTROLLED IN L5.
- A- DIMENSION D1, E1, L3 & b3 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.— SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- A- DIMENSION 61 & c1 APPLIED TO BASE METAL ONLY.
- 8.- DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 9.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252.
- 10. LEADS AND DRAIN ARE PLATED WITH 100% Sn

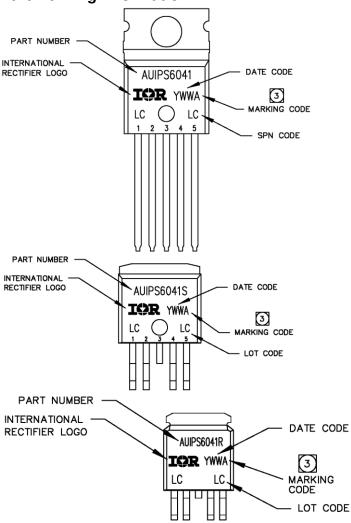
# Tape & Reel 5 Leads - DPAK



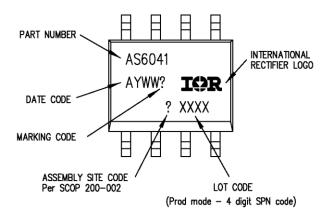
12. C CRITICAL DIMENSION



# **Part Marking Information**







# **Ordering Information**

Base Part Number		Standard Pack			
base Part Number	Package Type	Form	Quantity	Complete Part Number	
AUIPS6041	TO220-5-Leads	Tube	50	AUIPS6041	
		Tube	50	AUIPS6041S	
AUIPS6041S	D2-Pak-5-Leads	Tape and reel left	800	AUIPS6041STRL	
		Tape and reel right	800	AUIPS6041STRR	
	D-Pak-5-Leads	Tube	75	AUIPS6041R	
ALUDOCOAAD		Tape and reel	2000	AUIPS6041RTR	
AUIPS6041R		Tape and reel left	3000	AUIPS6041RTRL	
		Tape and reel right	3000	AUIPS6041RTRR	
ALUDOCO41C	SOIC-8	Tube	95	AUIPS6041G	
AUIPS6041G		Tape and reel	2500	AUIPS6041GTR	



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# International TOR Rectifier

# **AUIPS6041(G)(R)(S)**

**Revision History** 

Revision	Date	Notes/Changes
С	Februrary, 28th 2009	AU number update
D	March, 14th 2011	AU release
F	May 15, 2012	Add the test condition for the ICC (off) parameters